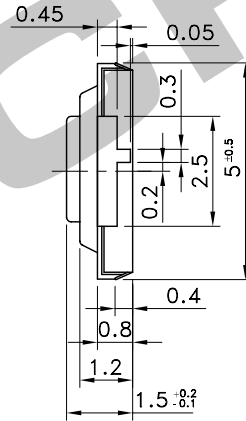
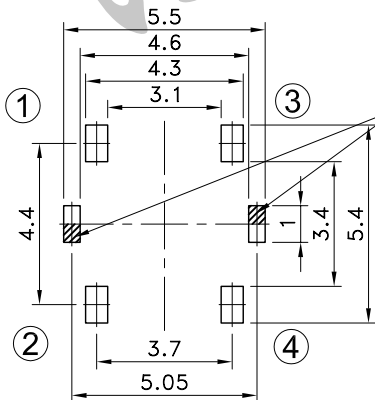


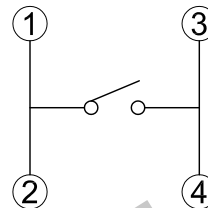
P.C.B TERMINAL POSITION



CIRCUIT ARRANGEMENT

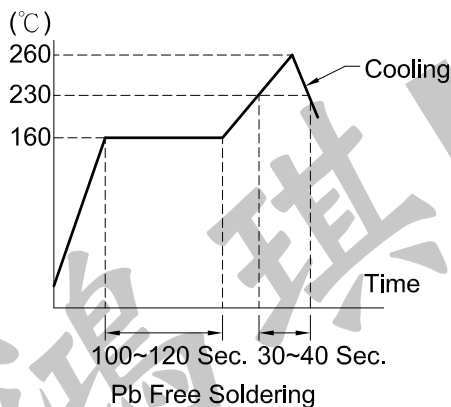


REFLOW SOLDERING CONDITIONS



SPECIFICATIONS

1. Rating : DC 15V 20mA
2. Contact Resistance : 50mΩ Max.
3. Insulation Resistance : 50MΩ Min. at DC 100V
4. Dielectric Strength : AC 250V For 1 Minute
5. Operating Force : 160±50gf
6. Stroke : 0.25^{+0.1}_{-0.2} mm
7. Life : 1,000,000 Cycles
8. Taping : 5,000 Pcs/Reel
9. Operating Temperature Range : -40~+85°C
10. Storage Temperature Range : -40~+85°C (Bulk)
: -20~+60°C (Taping)
11. Reflow Soldering Profile: According Reflow Profile
Max. 2 Times



REVISION:		DATE:		REVISION:		DATE:	
UNIT:mm	THIRD ANGLE PROJECTION METHOD	TOL. UNLESS OTHERWISE STATED:±0.3		CODE NO.:HCH-136-5			
ISSUED	CONFIRMED	HORNG CHIH 鴻琪股份有限公司 <small>ISO9001 Certified ISO14001 Certified</small>		PART NO.			
John	Elvis			STS-05-A			
2007.05.18	2007.05.18						